

Vishay Siliconix

## P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup> Q <sub>g</sub> (Typ.)				
- 30	0.0205 at V <sub>GS</sub> = - 10 V	- 11.6	12.4 nC			
- 30	0.0375 at V <sub>GS</sub> = -4.5 V	- 8.6	12.4110			

#### **FEATURES**

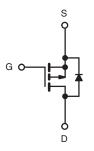
- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



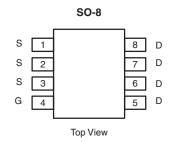
HALOGEN **FREE** 

#### **APPLICATIONS**

- · Load Switches, Adaptor Switch
  - Notebook PCs



P-Channel MOSFET



Ordering Information: Si4487DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage	V <sub>GS</sub>	± 25	v		
	T <sub>C</sub> = 25 °C		- 11.6		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 9.3		
Continuous Diain Current (1) = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 8.2 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 6.5 <sup>a, b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	- 50	Α		
	T <sub>C</sub> = 25 °C		- 4.1		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.0 <sup>a, b</sup>		
Avalanche Current	1 0 4 mal 1	I <sub>AS</sub>	- 15		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	11.25	mJ	
	T <sub>C</sub> = 25 °C		5.0		
Maniana Daniar Dissination	T <sub>C</sub> = 70 °C	1 , —	3.2	١٨/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	w	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	20	25	J C/W	

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 85 °C/W. d. Based on  $T_C = 25$  °C.

## **Si4487DY**

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		- 25		1400	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		4.7		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 100	nA	
Zara Cata Valtana Duain Comunant	1	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-1		- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α	
	_	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		0.0165	0.0205	Ω	
Drain-Source On-State Resistance <sup>a</sup>	H <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.030	0.0375		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 10 A		20		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1075			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		215		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			180			
Tatal Oata Obarra	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$		24	36	nC	
Total Gate Charge	$Q_g$			12.4	18.6		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$		3.4			
Gate-Drain Charge	$Q_{gd}$			5.8			
Gate Resistance	$R_g$	f = 1 MHz	1.1	5.5	11	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			9	18		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		8	16		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		28	50		
Fall Time	t <sub>f</sub>			10	20	ns	
Turn-On Delay Time	t <sub>d(on)</sub>			42	75	115	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		31	60		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN} =$ - 4.5 V, $R_g =$ 1 Ω		21	40		
Fall Time	t <sub>f</sub>			15	30		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.1	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				- 50		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			23	45	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	l <sub>F</sub> = - 5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		12	23	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$_{\text{IF}} = -5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{ I}_{\text{J}} = 25 \text{ °C}$		9		ne	
Reverse Recovery Rise Time	t <sub>b</sub>			15		ns	

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

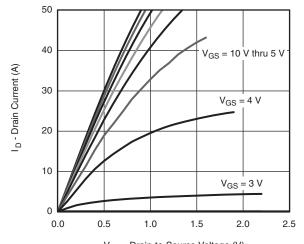
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

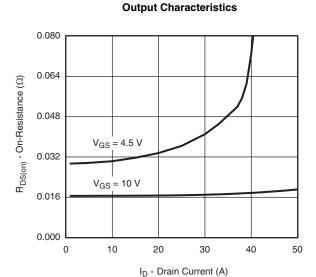


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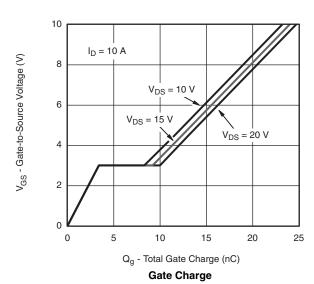
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



V<sub>DS</sub> - Drain-to-Source Voltage (V)

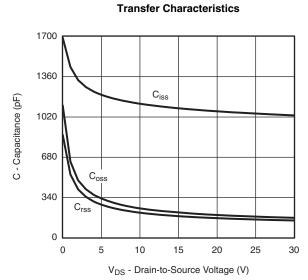


On-Resistance vs. Drain Current

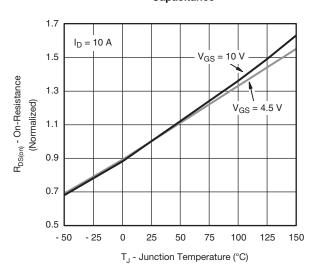


(v) trong of the state of the s

 $V_{GS}$  - Gate-to-Source Voltage (V)



Capacitance



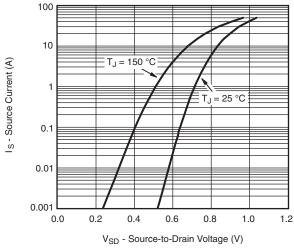
On-Resistance vs. Junction Temperature

## **Si4487DY**

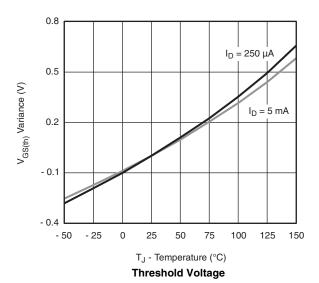
## Vishay Siliconix

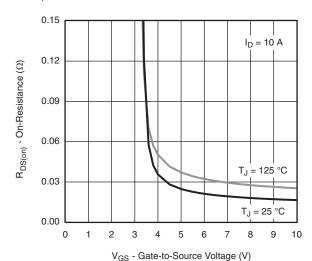
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

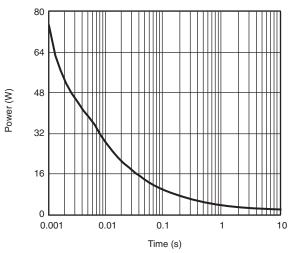


#### Source-Drain Diode Forward Voltage

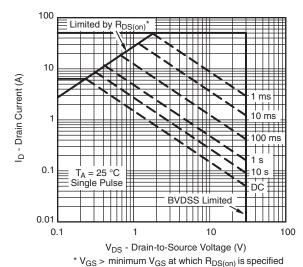




On-Resistance vs. Gate-to-Source Voltage



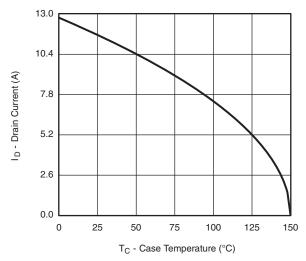
Single Pulse Power, Junction-to-Ambient



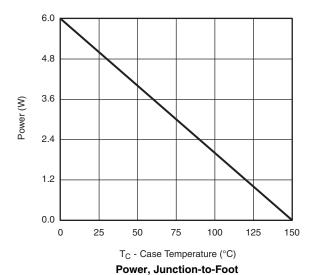


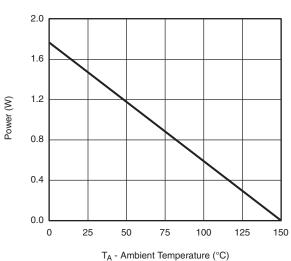
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Current Derating\***





Power Derating, Junction-to-Ambient

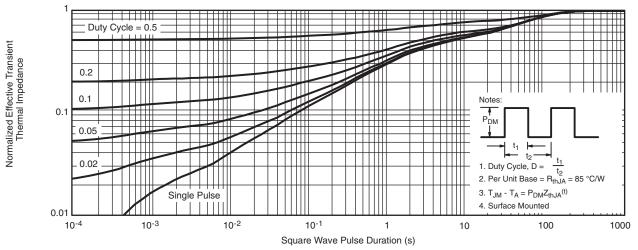
 $<sup>^*</sup>$  The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150  $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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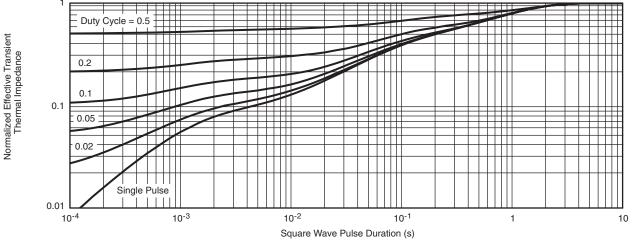
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?65473">www.vishay.com/ppg?65473</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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